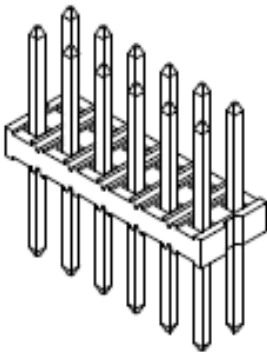




Part Number : [877581050](#)
Product Description : 2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 10 Circuits, 0.38µm Gold (Au) Selective Plating, Tray Packaging, Lead-Free
Series Number : 87758
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings
[877581050_sd.pdf](#)
[PK-89990-487-001.pdf](#)

3D Models and Design Files
[877581050_stp.zip](#)

Specifications
[503940001-AS-000.pdf](#)
[PS-87761-100-001.pdf](#)
[877610000-TS-000.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87758
Description	2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 10 Circuits, 0.38µm Gold (Au) Selective Plating, Tray Packaging, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Header
Product Name	Milli-Grid
UPC	822348273553

Agency

UL	E29179
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Electrical

Current - Maximum per Contact	2.0A
Voltage - Maximum	125V

Physical

Breakaway	Yes
Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0

Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Mated Height	5.50mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	0.297/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PC Tail Length	2.60mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	250

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Dual Row Receptacle Housings	<u>51110</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>78787</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>78788</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79107</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79108</u>
Milli-Grid Top/Bottom Entry Surface Mount PCB Receptacles	<u>79109</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>87381</u>